

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HYUNG HWAN KIM	06/20/2008
KWANG KEE CHAE	06/20/2008
JONG GOO JUNG	06/20/2008
OK MIN MOON	06/20/2008
YOUNG BANG LEE	06/20/2008
SUNG EUN PARK	06/20/2008
RECEIVING PARTY DATA	
Name:	HYNIX SEMICONDUCTOR INC.
Street Address:	San 136-1, Ami-ri, Bubal-eub, Icheon-si
City:	Kyoungki-do
State/Country:	KOREA, REPUBLIC OF
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12167322
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	CU-6819 WWP/NK
NAME OF SUBMITTER:	Woochoon W. Park

CH \$40.00 12167322

Total Attachments: 2

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UNITED STATES OF AMERICA
ASSIGNMENT

In consideration of the payment of ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for the other good and valuable consideration,

ASSIGNOR:

Name : Hyung Hwan KIM

Address : 702-1804, Hyundai 7-cha Apt., Ami-ri, Bubal-eup, Icheon-si, Gyeonggi-do, Korea

Name: Kwang Kee CHAE

Address: 101-1301, Hansol Solpark, Jeungpo-dong, Icheon-si, Gyeonggi-do, Korea

Name: Jong Goo JUNG

Address: 107-1001, Daemyung Lakeville, 946-beonji, Youngduk-ri, Giheung-eup, Yongin-si, Gyeonggi-do, Korea

Name: Ok Min MOON

Address: #302, 360-7, Yuljeon-dong, Jangan-gu, Suwon-si, Gyeonggi-do, Korea

Name: Young Bang LEE

Address: B-501, Taechangvilla, 594-24, 23/2, Juan 2-dong, Nam-gu, Incheon-si, Gyeonggi-do, Korea

Name: Sung Eun PARK

Address: 6-1005, Woseong Apt., Jamsil 7-dong, Songpa-gu, Seoul, Korea

(INVENTOR NAME AND ADDRESS)

hereby sells, assigns and transfers to

ASSIGNEE:

Name : Hynix Semiconductor Inc.

Address : San 136-1, Ami-ri, Bubal-eub, Icheon-si, Kyoungki-do, Korea

(ASSIGNEE NAME AND ADDRESS)

and the successors, assigns and legal representatives of the ASSIGNEE the entire right, title and interest for the United States and its territorial possessions in and to, any and all improvements which are disclosed in the invention entitled:

ISOLATION LAYER HAVING A BILAYER STRUCTURE FOR A SEMICONDUCTOR DEVICE AND METHOD FOR FORMING THE SAME

(TITLE)

and which is found in *(check one applicable item below)*

U.S. patent application executed on even date herewith

U.S. Application Serial No. _____ filed on _____

and, in and to all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, substitute, reissue or re-examination thereof.


ASSIGNOR hereby convenants that no assignment, sale agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;

ASSIGNOR further convenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference or litigation related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

IN WITNESS WHEREOF, I/we have set our hand and seal

June 20, 2008

Date



INVENTOR: Hyung Hwan KIM

June 20, 2008


Date



INVENTOR: Kwang Kee CHAE

June 20, 2008


Date



INVENTOR: Jong Goo JUNG

June 20, 2008


Date



INVENTOR: Ok Min MOON

June 20, 2008


Date



INVENTOR: Young Bang LEE

June 20, 2008

Date



INVENTOR: Sung Eun PARK

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